

Low-Power Long Range LoRa® Technology Transceiver Module

General Features

- On-Board LoRaWAN™ Protocol Stack
- ASCII Command Interface over UART
- Compact Form Factor: 17.8 x 26.7 x 3.34 mm
- Castellated SMT Pads for Easy and Reliable PCB Mounting
- · Environmentally Friendly, RoHS Compliant
- European R&TTE Directive Assessed Radio Module
- Device Firmware Upgrade (DFU) over UART, see *"RN2483 LoRa[®] Technology Module Command Reference User's Guide"* (DS40001784)

Operational

- Single Operating Voltage: 2.1V to 3.6V (3.3V typical)
- Temperature Range: -40°C to +85°C
- Low-Power Consumption
- Programmable RF Communication Bit Rate up to 300 kbps with FSK Modulation, 10937 bps with LoRa[®] Technology Modulation
- Integrated MCU, Crystal, EUI-64 Node Identity Serial EEPROM, Radio Transceiver with Analog Front End, Matching Circuitry
- 14 GPIOs for Control and Status, Shared with 13 Analog Inputs

RF/Analog Features

- Low-Power Long Range Transceiver Operating in the 433 MHz and 868 MHz Frequency Bands
- · High Receiver Sensitivity: Down to -146 dBm
- TX Power: Adjustable up to +14 dBm high Efficiency PA
- FSK, GFSK, and LoRa Technology Modulation
- IIP3 = -11 dBm
- Up to 15 km Coverage at Suburban and up to 5 km Coverage at Urban Area



Description

Microchip's RN2483 Low-Power Long Range LoRa Technology Transceiver module provides an easy to use, low-power solution for long range wireless data transmission. The advanced command interface offers rapid time to market.

The RN2483 module complies with the LoRaWAN Class A protocol specifications. It integrates RF, a baseband controller, command Application Programming Interface (API) processor, making it a complete long range solution.

The RN2483 module is suitable for simple long range sensor applications with external host MCU.

Applications

- · Automated Meter Reading
- · Home and Building Automation
- · Wireless Alarm and Security Systems
- Industrial Monitoring and Control
- Machine to Machine (M2M)
- Internet of Things (IoT)

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When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

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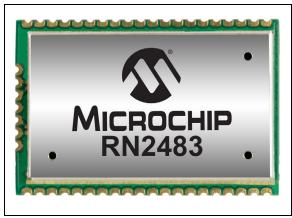
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1.0 DEVICE OVERVIEW

The RN2483 transceiver module features LoRa Technology RF modulation, which provides long range spread spectrum communication with high interference immunity.

Using LoRa Technology modulation technique, RN2483 can achieve a receiver sensitivity of -146 dBm. The high sensitivity combined with the integrated +14 dBm power amplifier yields industry leading link budget, which makes it optimal for applications requiring extended range and robustness.

FIGURE 1-1: RN2483 TOP VIEW



LoRa Technology modulation also provides significant advantages in both blocking and selectivity compared to the conventional modulation techniques, solving the traditional design compromise between extended range, interference immunity, and low-power consumption.

The RN2483 module delivers exceptional phase noise, selectivity, receiver linearity, and IIP3 for significantly lower power consumption. Figure 1-1, Figure 1-2, and Figure 1-3 show the top view, the pinout, and the block diagram of the module.

FIGURE 1-2: RN2483 PIN DIAGRAM

5 8 8 8 8 7					
-28 GND	CINE CONTRACTOR CONTRA	20			
29 NC 30 PGC_INT 31 PGD_INT	NC	19			
<u>30 PGC_INT</u>	NC	18			
<u>31 PGD_INT</u>	NC	17			
32 RESET	NC	16			
33 GND	NC	15			
33 GND 34 VDD 35 GPI00	GPIO10	14			
35 GPIO0	GPIO11	13			
<u>-36</u> GPIO1 - <u>37</u> GPIO2	VDD	12			
37 GPIO2	GND	11			
38 GPIO3	GPIO12	10			
39 GPIO4	CPIO12	9			
40 GPIO5	GND	8			
41 GND	UART_RX	7			
42 NC 43 GP106 44 GP107	UART_TX	6			
43 GPIO6	RESERVED	5			
44 GPIO7	RESERVED	4			
45 GPIO8	UART_CTS	3			
46 GPIO9	UART_RTS	2			
47 GND	GND	1			

FIGURE 1-3:

RN2483 BLOCK DIAGRAM

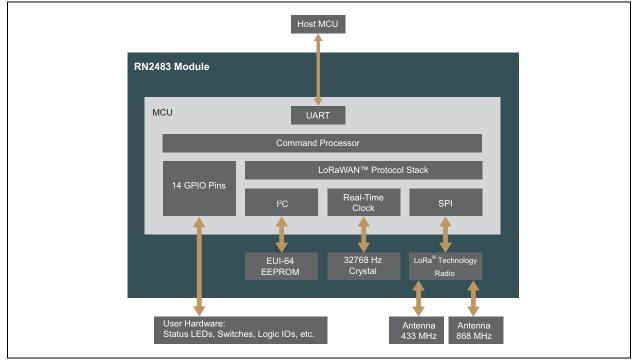


Table 1-1 describes the RN2483 pins.TABLE 1-1:PIN DESCRIPTION

Pin	Name	Туре	Description	
1	GND	Power	Ground supply terminal	
2	UART_RTS	Output	Communication UART RTS signal ⁽¹⁾ , or GPIO	
3	UART_CTS	Input	Communication UART CTS signal ⁽¹⁾ , or GPIO	
4	RESERVED	_	Do not connect	
5	RESERVED	—	Do not connect	
6	UART_TX	Output	Communication UART Transmit (TX)	
7	UART_RX	Input	Communication UART Receive (RX)	
8	GND	Power	Ground supply terminal	
9	GPIO13	Input/Output	General purpose I/O pin or analog input	
10	GPIO12	Input/Output	General purpose I/O pin or analog input	
11	GND	Power	Ground supply terminal	
12	VDD	Power	Positive supply terminal	
13	GPIO11	Input/Output	General purpose I/O pin or analog input	
14	GPIO10	Input/Output	General purpose I/O pin or analog input	
15	NC	—	Not connected	
16	NC	_	Not connected	
17	NC	_	Not connected	
18	NC	_	Not connected	
19	NC	_	Not connected	
20	GND	Power	Ground supply terminal	
21	GND	Power	Ground supply terminal	
22	GND	Power	Ground supply terminal	
23	RFH	RF analog	RF signal pin for high band	
24	GND	Power	Ground supply terminal	
25	RFL	RF analog	RF signal pin for low band	
26	GND	Power	Ground supply terminal	
27	GND	Power	Ground supply terminal	
28	GND	Power	Ground supply terminal	
29	NC	_	Not connected	
30	PGC_INT	Input/Output	Internal MCU ICSP program clock or general purpose I/O pin ⁽²⁾	
31	PGD_INT	Input/Output	Internal MCU ICSP program data or general purpose I/O pin ⁽²⁾	
32	RESET	Input	Active-low device Reset input	
33	GND	Power	Ground supply terminal	
34	VDD	Power	Positive supply terminal	
35	GPIO0	Input/Output	General purpose I/O pin or analog input	
36	GPIO1	Input/Output	General purpose I/O pin or analog input	
37	GPIO2	Input/Output	General purpose I/O pin or analog input	
38	GPIO3	Input/Output	General purpose I/O pin or analog input	
39	GPIO4	Input/Output	General purpose I/O pin	
40	GPIO5	Input/Output	General purpose I/O pin or analog input	
41	GND	Power	Ground supply terminal	
42	NC		Not connected	

Pin Name		Туре	Description		
43	GPIO6	Input/Output	General purpose I/O pin or analog input		
44	GPI07	Input/Output	General purpose I/O pin or analog input		
45	GPIO8	Input/Output	General purpose I/O pin or analog input		
46	GPIO9	Input/Output	General purpose I/O pin or analog input		
47	GND	Power	Ground supply terminal		

TABLE 1-1: PIN DESCRIPTION (CONTINUED)

Note 1: Optional handshake lines are supported in future firmware releases.

2: The "RN2483 LoRa[®] Technology Module Command Reference User's Guide" (DS40001784F) uses the pin name TEST0 for PGC_INT and TEST1 for PGD_INT.

2.0 GENERAL SPECIFICATIONS

Table 2-1 provides the general specifications for the module. Table 2-2, Table 2-3, and Table 2-4 provide the electrical characteristics, current consumption, and

TABLE 2-1: GENERAL SPECIFICATIONS

dimensions of the module, respectively. Table 2-5 shows the RF output power calibration data. Table 2-6 shows the RF output power at different supply voltages and temperatures.

Specification	Description	
Frequency Band	863.000 MHz to 870.000 MHz; 433.050 MHz to 434.790 MHz	
Modulation Method	FSK, GFSK, and LoRa [®] Technology modulation	
Maximum Over-the-Air Data Rate	300 kbps with FSK modulation; 10937 bps with LoRa Technology modulation	
RF Connection	Board edge connection	
Interface	UART	
Operation Range Up to 15 km coverage at suburban; up to 5 km coverage at urban are		
Sensitivity at 1% PER	-146 dBm ⁽¹⁾	
RF TX Power	Adjustable up to max. 10 dBm on 433 MHz band (limited to meet regulations); max. 14 dBm on the 868 MHz band ⁽²⁾	
Temperature (operating)	-40°C to +85°C	
Temperature (storage)	-40°C to +115°C	
Humidity	10% ~ 90% non-condensing	

Note 1: Dependent on modulation settings, Receiver Bandwidth (RBW), and Spreading Factor (SF).

2: TX power is adjustable. For more information, refer to the "RN2483 LoRa[®] Technology Module Command Reference User's Guide" (DS40001784).

TABLE 2-2: ELECTRICAL CHARACTERISTICS

Parameter	Min.	Тур.	Max.	Units
Supply Voltage	2.1		3.6	V
Voltage on any pin with respect to VSS (except VDD) and RESET	-0.3	_	VDD + 0.3	V
Voltage on VDD with respect to VSS	-0.3	_	3.9	V
Voltage on RESET with respect to VSS	0	_	+11	V
Input Clamp Current (IIK) (VI < 0 or VI > VDD)	—	—	+/-20	mA
Output Clamp Current (IOK) (VO < 0 or VO > VDD)	—	_	+/-20	mA
GPIO sink/source current each	—	—	25/25	mA
Total GPIO sink/source current	—	_	200/185	mA
RAM Data Retention Voltage (in Sleep mode or Reset state)	1.5	_	—	V
VDD Start Voltage to ensure internal Power-on Reset signal	—	_	0.7	V
VDD Rise Rate to ensure internal Power-on Reset signal	0.05	_	—	V/ms
Brown-out Reset Voltage	1.75	1.9	2.05	V
Logic Input Low Voltage	—	_	0.15 x VDD	V
Logic Input High Voltage	0.8 x VDD	_	—	V
Input Leakage at <25°C (VSS <vpin<vdd, at="" high-impedance)<="" pin="" td=""><td>—</td><td>0.1</td><td>50</td><td>nA</td></vpin<vdd,>	—	0.1	50	nA
Input Leakage at +60°C (VSS <vpin<vdd, at="" high-impedance)<="" pin="" td=""><td>—</td><td>0.7</td><td>100</td><td>nA</td></vpin<vdd,>	—	0.7	100	nA
Input Leakage at +85°C (VSS <vpin<vdd, at="" high-impedance)<="" pin="" td=""><td>—</td><td>4</td><td>200</td><td>nA</td></vpin<vdd,>	—	4	200	nA
RF Input Level	—	_	+10	dBm

TABLE 2-3: CURRENT CONSUMPTION

Mode	Temperature		Typical Current (mA)	
Mode	(°C) VDD = 2.1V	VDD = 3.3V	VDD = 3.6V	
Idle	-40 to +85	1.7	2.8	3.1
Transmit	25	28.6	38.9	44.5
	-40	0.0011	0.0013	0.0014
Sleep	25	0.0015	0.0016	0.0016
	85	0.002	0.0026	0.0026

TABLE 2-4: MODULE DIMENSIONS

Parameter	Value
Dimensions	17.8 x 26.7 x 3.34 mm
Weight	2.05g

TABLE 2-5: OUTPUT POWER OF TX POWER SETTING

Band	TX Power Setting	Output Power (dBm)	Typical Supply Current at 3.3V (mA)
	-3	-4.0	17.3
	-2	-2.9	18.0
	-1	-1.9	18.7
	0	-1.7	20.2
	1	-0.6	21.2
	2	0.4	22.3
	3	1.4	23.5
	4	2.5	24.7
	5	3.6	26.1
868 MHz	6	4.7	27.5
	7	5.8	28.8
	8	6.9	30.0
	9	8.1	31.2
	10	9.3	32.4
	11	10.4	33.7
	12	11.6	35.1
	13	12.5	36.5
	14	13.5	38.0
	15	14.1	38.9

Band	TX Power Setting	Output Power (dBm)	Typical Supply Current at 3.3V (mA)
	-3	-3.5	14.7
	-2	-2.3	15.1
	-1	-1.3	15.6
	0	-2.3	15.8
	1	-1.2	16.4
	2	-0.1	17.0
	3	1.0	17.7
	4	2.1	18.5
	5	3.2	19.4
433 MHz	6	4.3	20.3
	7	5.4	21.4
	8	6.5	22.3
	9	7.6	23.3
	10	8.8	24.5
	11	9.9	25.8
	12	10.9	27.3
	13	11.9	28.8
	14	12.9	30.7
	15	13.6	32.9

TABLE 2-5: OUTPUT POWER OF TX POWER SETTING (CONTINUED)

TABLE 2-6: OUTPUT POWER OF SUPPLY VOLTAGE AND TEMPERATURE

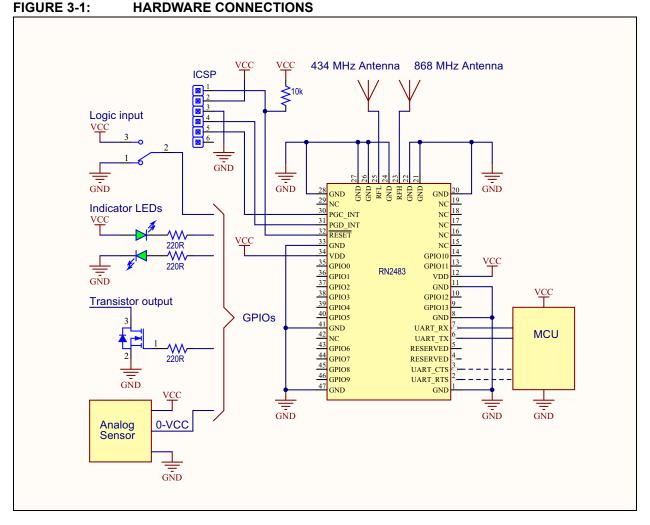
Temperature	Туріса	al Output Power at 868 MHz	(dBm)
(°C)	VDD = 2.1V	VDD = 3.3V	VDD = 3.6V
-40	10.5	13.8	13.7
25	10.0	14.1	14.6
85	9.1	13.4	13.7

TABLE 2-7: OUTPUT POWER OF SUPPLY VOLTAGE AND TEMPERATURE

Temperature	Туріса	al Output Power at 434 MHz	(dBm)
(°C)	VDD = 2.1V	VDD = 3.3V	VDD = 3.6V
-40	10.1	13.2	13.2
25	9.7	13.6	14.2
85	9.3	13.0	13.4

3.0 TYPICAL HARDWARE CONNECTIONS

Figure 3-1 shows the typical hardware connections.



3.1 Interface to Host MCU

The RN2483 module has a dedicated UART interface to communicate with a host controller. Optional handshake lines are supported in future firmware releases. The *"RN2483 LoRa® Technology Module Command Reference User's Guide"* (DS40001784) provides a detailed UART command description. Table 3-1 shows the default settings for the UART communication.

TABLE 3-1:	DEFAULT UART SETTINGS
------------	-----------------------

Specification	Description
Baud Rate	57600 bps
Packet Length	8 bit
Parity Bit	No
Stop Bits	1 bit
Hardware Flow Control	No

3.2 GPIO Pins (GPIO0-GPIO13)

The module has 14 GPIO pins. These lines can be connected to switches, LEDs, and relay outputs. The pins can be either logic inputs or outputs, and some pins (see Table 1-1) have analog input capability that can be accessed via the module firmware. These pins have limited sink and source capabilities. Electrical characteristics are described in Table 2-2. For more information, see "*RN2483 LoRa*[®] *Technology Module Command Reference User's Guide*" (DS40001784).

3.3 RF Connections (RFL, RFH)

RFL is the RF analog port for the lower frequency band (433 MHz) while RFH is for the higher frequency band (868 MHz). When routing RF paths, use proper strip lines with an impedance of 50 Ohm.

3.4 RESET Pin

The RESET pin of the module is an active-low logic input. An internal weak pull-up resistor is enabled when the pin is configured as the MCLR input.

3.5 Power Pins

It is recommended to connect power pins (Pin 12 and 34) to a stable supply voltage with sufficient source current. Table 2-3 shows the current consumption.

Additional filtering capacitors are not required but used to ensure stable supply voltage in a noisy environment.

3.6 Internal Program Pins

PGC_INT (Pin 30) and PGD_INT (Pin 31) are internal program pins used during manufacturing. For normal operation, these pins can be left unconnected.

The normal firmware upgrade method is through the internal bootloader of the module via the UART. The method is documented in the *"RN2483 LoRa® Technology Module Command Reference User's Guide"* (DS40001784).

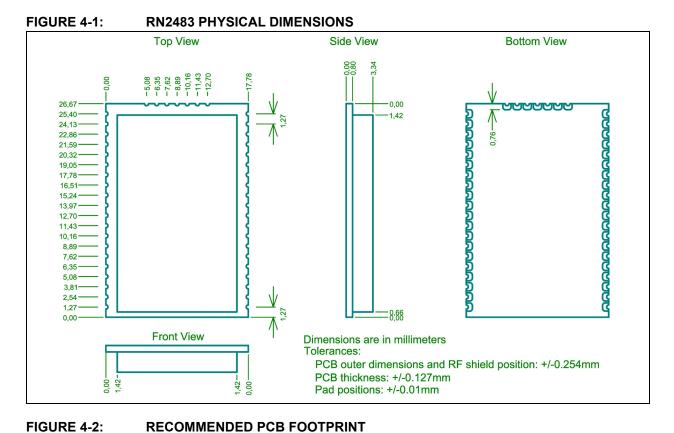
However, for backup firmware update purposes the user can place a 6-pin ICSP header on their host PCB with PGC_INT (Pin 30), PGD_INT (Pin 31), RESET (Pin 32), power and ground.

During High Voltage In-Circuit Serial Programming mode, the RESET pin is driven with high-voltage (9V), therefore protection may be necessary for sensitive devices.

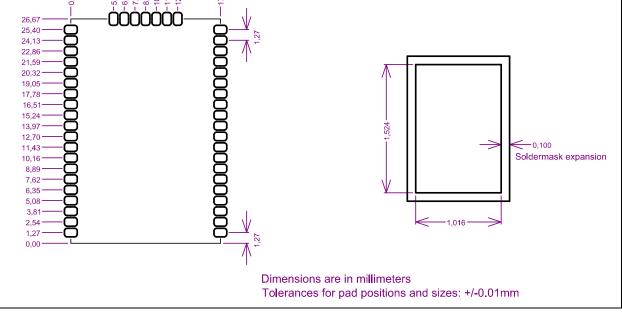
Note: Only official Microchip Technology firmware released for the RN2483 module shall be used to maintain FCC and IC certification.

4.0 PHYSICAL DIMENSIONS

Figure 4-1 and Figure 4-2 illustrate the physical dimensions and the recommended PCB layout for the RN2483 module.



Top View Pad Details .5,08 6,35 7,62 8,89 10,16 11,43 11,43 0,00 0000000 26,67 25,40 24,13 22,86 21,59



5.0 APPLICATION INFORMATION

5.1 RF Trace Layout Design

The RN2483 modular transmitter is certified with a PCB edge SMA connector and micro-strip trace layout as shown in Figure 5-1 and Figure 5-2. The two RF paths



are axisymmetric with the same linear dimensions. The host PCB can follow these trace design to maintain compliance under the modular grant (FCC) and certificate (IC). Gerber files are available on the RN2483 product web page at www.microchip.com/ RN2483.

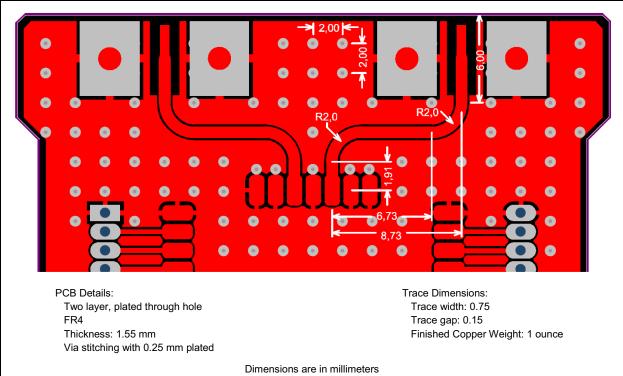
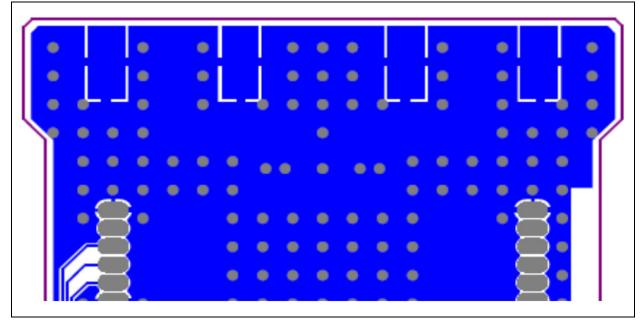


FIGURE 5-2: RF TRACE ROUTING (BOTTOM LAYER)



6.0 **REGULATORY APPROVAL**

This section outlines the regulatory information for the RN2483 module for Europe.

6.1 Europe

The RN2483 module is an R&TTE Directive assessed radio module that is CE marked and has been manufactured and tested with the intention of being integrated into a final product.

The RN2483 module has been tested to R&TTE Directive 1999/5/EC Essential Requirements for Health and Safety (Article 3.1a), Electromagnetic Compatibility (EMC) (Article 3.1b), and Radio (Article 3.2) and are summarized in Table 6-1: European Compliance Testing. A Notified Body Opinion has also been issued. All test reports are available on the product web page at http://www.microchip.com.

The R&TTE Compliance Association provides guidance on modular devices in document **Technical Guidance Note 01** available at

http://www.rtteca.com/html/download_area.htm.

To maintain conformance to the testing Note: listed in Table 6-1: European Compliance Testing, the module shall be installed in accordance with the installation instructions in this data sheet and shall not be modified. When integrating a radio module into a completed product the integrator becomes the manufacturer of the final product and is therefore responsible for demonstrating compliance of the final product with the essential requirements of the R&TTE Directive.

6.1.1 LABELING AND USER INFORMATION REQUIREMENTS

The label on the final product which contains the RN2483 module must follow CE marking requirements. The *"R&TTE Compliance Association Technical Guidance Note 01"* provides guidance on final product CE marking.

TABLE 6-1: EUROPEAN COMPLIANCE TESTING

6.1.2 EXTERNAL ANTENNA REQUIREMENTS

From R&TTE Compliance Association document **Technical Guidance Note 01**:

Provided the integrator installing an assessed radio module with an integral or specific antenna and installed in conformance with the radio module manufacturer's installation instructions requires no further evaluation under Article 3.2 of the R&TTE Directive and does not require further involvement of an R&TTE Directive Notified Body for the final product (Section 2.2.4).

6.1.3 HELPFUL WEB SITES

A document that can be used as a starting point in understanding the use of Short Range Devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, which can be downloaded from the European Radio Communications Office (ERO) at: http://www.ero.dk/.

Additional helpful web sites are:

- Radio and Telecommunications Terminal Equipment (R&TTE): http://ec.europa.eu/enterprise/sectors/rtte/ regulatory-framework/index_en.htm
- European Conference of Postal and Telecommunications Administrations (CEPT): http://www.cept.org
- European Telecommunications Standards Institute (ETSI): http://www.etsi.org
- European Radio Communications Office (ERO): http://www.ero.dk/
- The Radio and Telecommunications Terminal Equipment Compliance Association (R&TTE CA): http://www.rtteca.com/

Certification	Standards	Article	Laboratory	Report Number	Date	
Safety	IEC 60950-1:2005 (2nd Ed: A1:2009)	(3.1a)	TRaC Global Ltd.	TRA-025134-43-00A	2/12/2015	
Health	EN 62479	—	TRaC Global Ltd.	TRA-025134-01-47-03A	2/12/2015	
EMC	EN 301 489-3 v1.6.1	(3.1b)	TRaC Global Ltd.	TRA-025134-43-00A	2/12/2015	
Radio	EN 300 220-2 v2.4.1	(3.2)	TRaC Global Ltd.	TRA-025134-01-47-00A (433 MHz) TRA-025134- 01-47-01A(868MHz)	2/12/2015	

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (March 2015)

This is the initial release of this document.

Revision B (December 2015)

This revision includes the following updates:

- Updated Deep Sleep value in Table 2-3
- Updated Dimensions value in Table 2-4
- Updated Figure 4-1
- Updated Figure 4-2
- Added Figure 5-2
- Updated information for Section 5.1 "RF Trace Layout Design".

Revision C (April 2017)

This revision includes the following updates:

- Updated Figure 1-2 and Figure 3-1
- Updated Table 1-1, Table 2-2, and Table 2-3
- Added Table 2-6 and Table 2-7
- Updated Section 3.4 "RESET Pin"
- Added Section 3.6 "Internal Program Pins"
- Deleted Section "5.2 Application Schematic".

NOTES:

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NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	ł	RM	xxx	Examples:
Device	Temperature Range	Package	Firmware Revision Number	RN2483A-I/RM: Industrial temperature
Device:	RN2483:	Low-Power Long Range Transceiver module	LoRa [®] Technology	
Temperature Range:	I =	-40°C to +85°C (Industri	ial)	
Package:	RM =	Radio Module		

NOTES:

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- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

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